

TM20P10D

P -Channel Enhancement Mosfet

General Description

- Low $R_{DS(ON)}$
- RoHS and Halogen-Free Compliant

Applications

- Load switch
- PWM

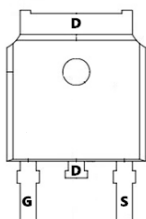
General Features

$V_{DS} = -100V$ $I_D = -20A$

$R_{DS(ON)} = 85m\Omega(\text{typ.}) @ V_{GS} = -10V$

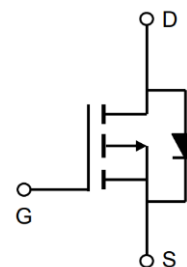
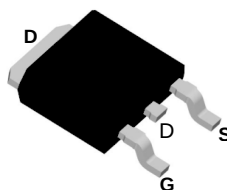
100% UIS Tested

100% R_g Tested



Marking: 20P10

D:TO-252-3L



Absolute Maximum Ratings ($T_A = 25^\circ C$, unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-100	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	$T_C = 25^\circ C$	A
		$T_C = 100^\circ C$	
Pulsed Drain Current ¹	I_{DM}	-74	A
Single Pulse Avalanche Energy ²	EAS	132.25	mJ
Total Power Dissipation	P_D	70	W
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^\circ C$

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Ambient ³	$R_{\theta JA}$	75	$^\circ C/W$
Thermal Resistance from Junction-to-Case	$R_{\theta JC}$	1.78	$^\circ C/W$

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Electrical Characteristics ($T_J = 25^\circ\text{C}$, unless otherwise noted)

Parameter		Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static Characteristics							
Drain-Source Breakdown Voltage		V _{(BR)DSS}	V _{GS} = 0V, I _D = -250μA	-100	-	-	V
Gate-body Leakage current		I _{GSS}	V _{DS} = 0V, V _{GS} = ±20V	-	-	±100	nA
Zero Gate Voltage Drain Current	T _J = 25°C	I _{DSS}	V _{DS} = -100V, V _{GS} = 0V	-	-	-1	μA
	T _J = 100°C			-	-	-100	
Gate-Threshold Voltage		V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250μA	-1	-1.6	-2.5	V
Drain-Source On-Resistance ⁴		R _{DS(on)}	V _{GS} = -10V, I _D = -10A	-	85	90	mΩ
			V _{GS} = -4.5V, I _D = -6A		88	105	
Forward Transconductance ⁴		g _{fs}	V _{DS} = -10V, I _D = -10A	-	30	-	S
Dynamic Characteristics ⁵							
Input Capacitance		C _{iss}	V _{DS} = -50V, V _{GS} = 0V, f = 1MHz	-	1985	-	pF
Output Capacitance		C _{oss}		-	85	-	
Reverse Transfer Capacitance		C _{rss}		-	71	-	
Gate Resistance		R _g	f = 1MHz	-	4	-	Ω
Switching Characteristics ⁵							
Total Gate Charge		Q _g	V _{GS} = -10V, V _{DS} = -50V, I _D = -10A	-	65	-	nC
Gate-Source Charge		Q _{gs}		-	10.2	-	
Gate-Drain Charge		Q _{gd}		-	13	-	
Turn-On Delay Time		t _{d(on)}	V _{GS} = -10V, V _{DD} = -50V, R _G = 3Ω, I _D = -10A	-	12.8	-	ns
Rise Time		t _r		-	30	-	
Turn-Off Delay Time		t _{d(off)}		-	82	-	
Fall Time		t _f		-	61	-	
Body Diode Reverse Recovery Time		t _{rr}	I _F = -10A, dI/dt= 100A/μs	-	62	-	ns
Body Diode Reverse Recovery Charge		Q _{rr}		-	56	-	nC
Drain-Source Body Diode Characteristics							
Diode Forward Voltage ⁴		V _{SD}	I _S = -10A, V _{GS} = 0V	-	-	-1.2	V
Continuous Source Current	T _C = 25°C	I _S	-	-	-	-20	A

Notes:

1. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)} = 150^\circ\text{C}$.
2. The EAS data shows Max. rating . The test condition is $V_{DD} = -35V, V_{GS} = -10V, L = 0.5\text{mH}, I_{AS} = -23A$
3. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper, The value in any given application depends on the user's specific board design.
4. The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
5. This value is guaranteed by design hence it is not included in the production test..

Typical Characteristics

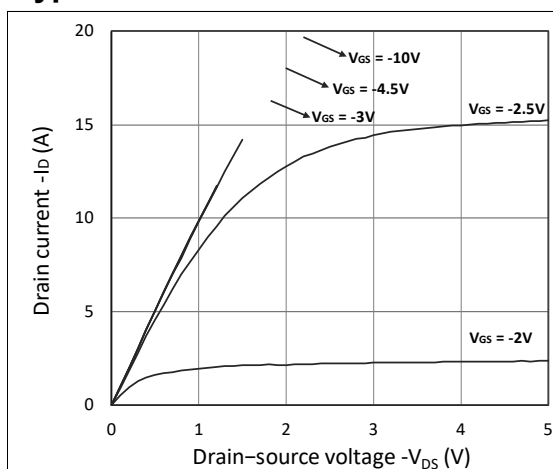


Figure 1. Output Characteristics

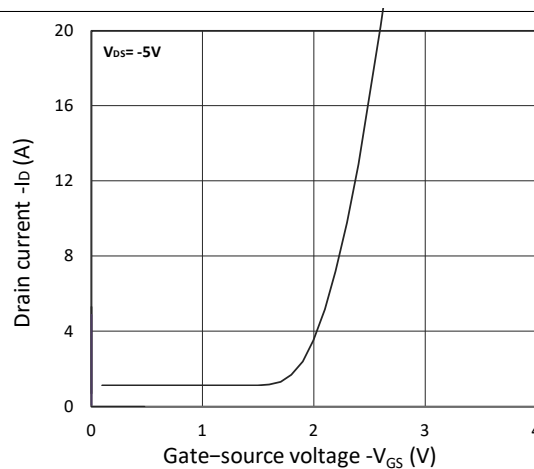


Figure 2. Transfer Characteristics

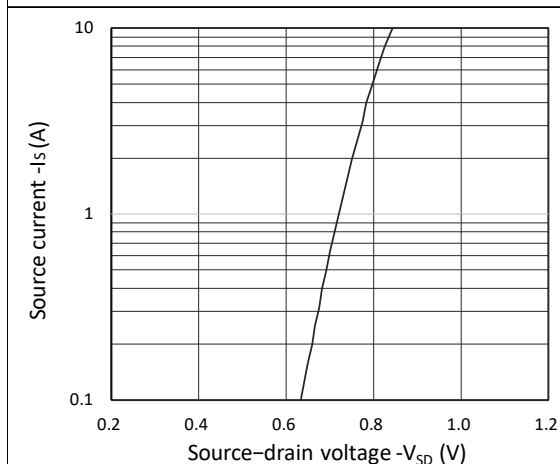


Figure 3. Forward Characteristics of Reverse

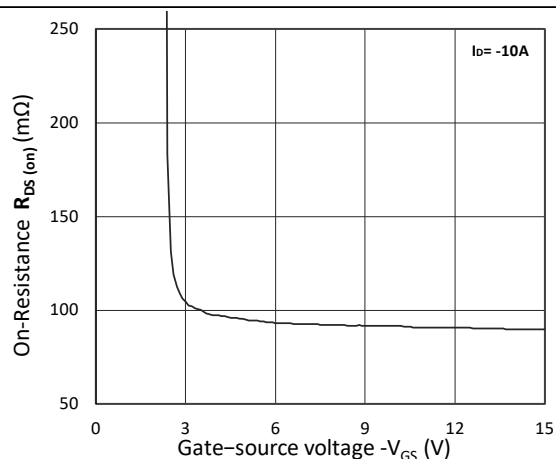


Figure 4. $R_{DS(ON)}$ vs. V_{GS}

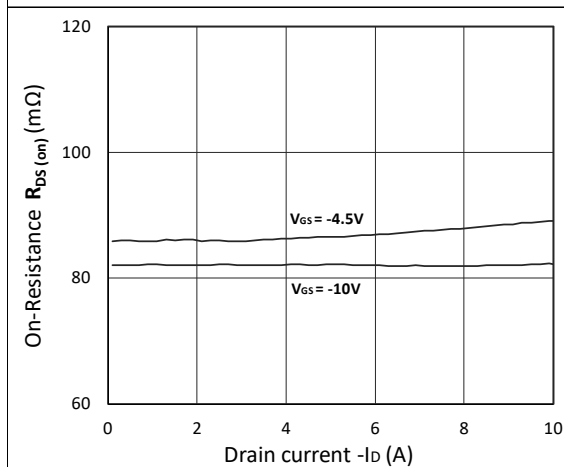


Figure 5. $R_{DS(ON)}$ vs. I_D

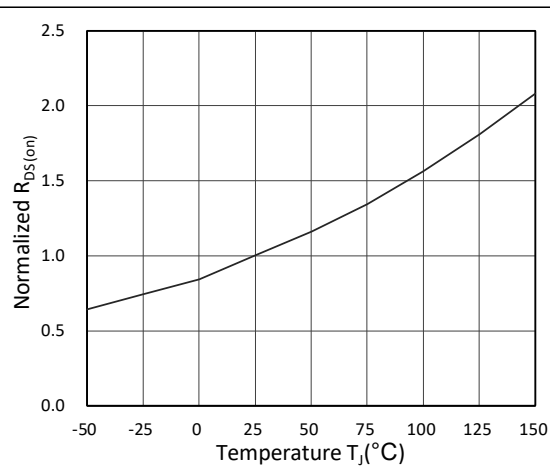


Figure 6. Normalized $R_{DS(ON)}$ vs. Temperature

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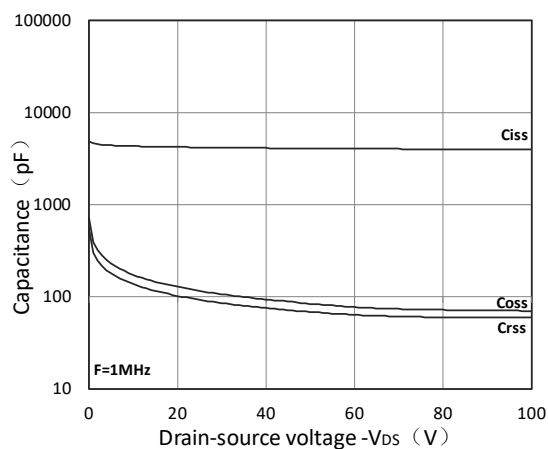


Figure 7. Capacitance Characteristics

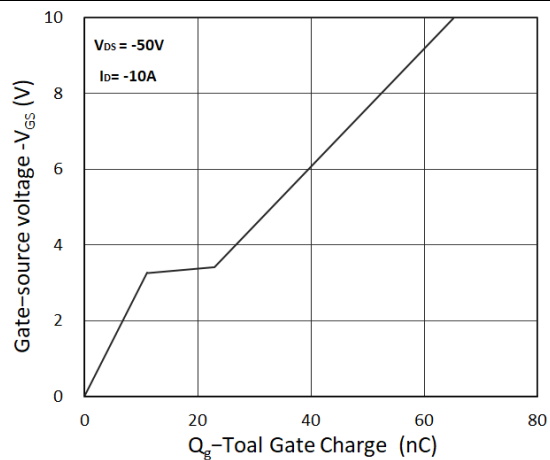


Figure 8. Gate Charge Characteristics

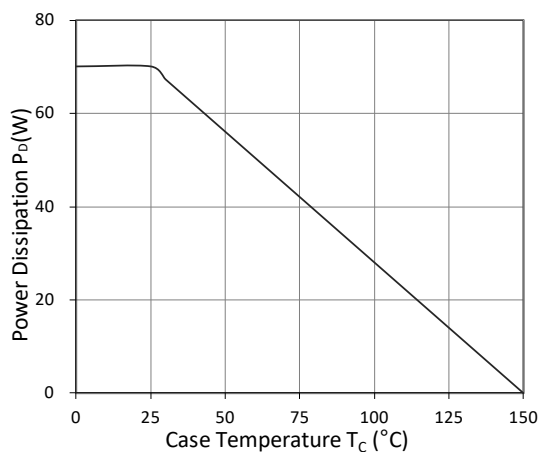


Figure 9. Power Dissipation

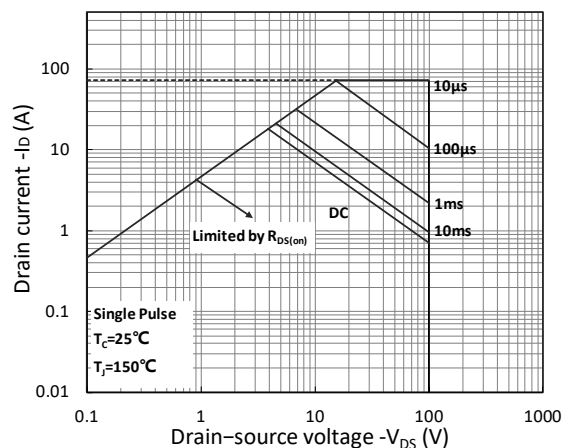


Figure 10. Safe Operating Area

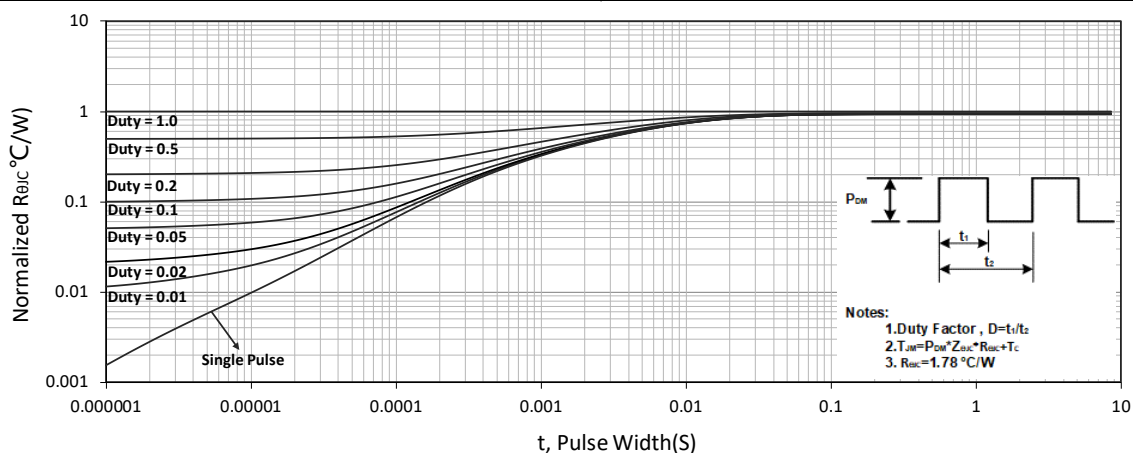
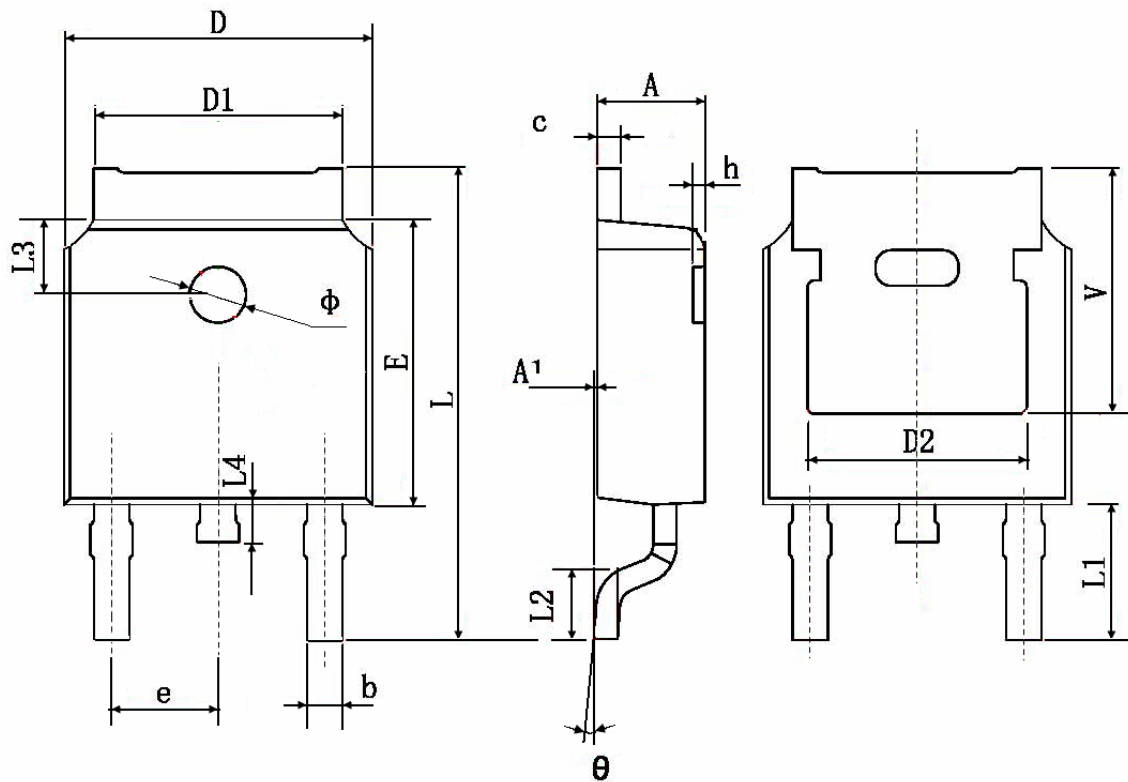


Figure 11. Normalized Maximum Transient Thermal Impedance

Package Information:TO-252-3L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 TYP.		0.190 TYP.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 TYP.		0.114 TYP.	
L2	1.400	1.700	0.055	0.067
L3	1.600 TYP.		0.063 TYP.	
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.350 TYP.		0.211 TYP.	